Data Sheet 26185.112B

A6821

DABiC-5 8-Bit Serial Input Latched Sink Drivers

Package A 16-pin DIP

Package LW 16-pin Wide Body SOIC



ABSOLUTE MAXIMUM RATINGS

Output Voltage, V _{OUT} 50 V
Logic Supply Voltage, V _{DD} 7 V
Input Voltage Range, V $_{\hspace{1em}I\hspace{1em}N}$ $-0.3V$ to $V_{\hspace{1em}D\hspace{1em}D}+0.3V$
Continuous Output Current (each output), $I_{\mbox{\scriptsize OUT}} \dots 500~\mbox{\scriptsize mA}$
Package Power Dissipation, P _D
A6821SA/A6821EA 2.1 W
A6821SLW
Operating Temperature Range
Ambient Temperature, T _A 20°C to +85°C
Storage Temperature, T _S 55°C to +150°C

Caution: CMOS devices have input-static protection, but are susceptible to damage when exposed to extremely high static-electrical charges.

A merged combination of bipolar and MOS technology gives these devices an interface flexibility beyond the reach of standard logic buffers and power driver arrays. Typical applications include driving multiplexed LED displays or incandescent lamps.

The A6821 has an eight-bit CMOS shift register and CMOS control circuitry, eight CMOS data latches, and eight bipolar current-sinking Darlington output drivers.

The CMOS inputs are compatible with standard CMOS logic levels. TTL circuits may require the use of appropriate pull-up resistors. By using the serial data output, the drivers can be cascaded for interface applications requiring additional drive lines.

The A6821SA is furnished in a standard 16-pin plastic DIP. The A6821EA is a 16-pin plastic DIP, capable of operation from -40°C to +85°C. The A6821SLW is a 16-lead wide-body SOIC, for surface-mount applications. These devices are lead (Pb) free, with 100% matte tin plated leadframes.

FEATURES

- 3.3 V to 5 V logic supply range
- Power on reset (POR)
- To 10 MHz data input rate
- CMOS, TTL compatible
- -40°C operation available
- Schmitt trigger inputs for improved noise immunity
- Low-power CMOS logic and latches
- High-voltage current-sink outputs
- Internal pull-up/pull down resistors

APPLICATIONS

- Multiplexed LED displays
- Incandescent lamps



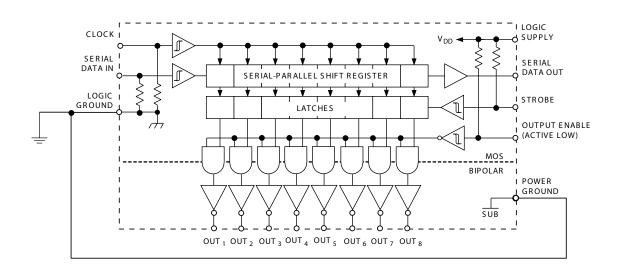
Use the following complete part numbers when ordering:

Part Number	Package	Ambient
A6821SA-T	16-pin DIP	–20°C to +85°C
A6821EA-T	16-pin DIP	–40°C to +85°C
A6821SLW-T	16-pin wide body SOIC	–20°C to +85°C

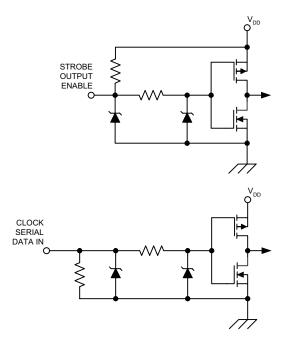




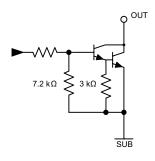
Functional Block Diagram



Typical Input Circuits



Typical Output Driver



ELECTRICAL CHARACTERISTICS¹ Unless otherwise noted: $T_A = 25^{\circ}C$, logic supply operating voltage $V_{dd} = 3.0 \text{ V to } 5.5 \text{ V}$

			V _{dd} = 3.3 V		\				
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Output Leakage Current	I _{CEX}	V _{OUT} = 50 V	-	_	10	-	_	10	μA
Oallantan Freittan Oatsmatian		I _{OUT} = 100 mA	_	_	1.1	_	_	1.1	V
Collector–Emitter Saturation Voltage	V _{CE(SAT)}	I _{OUT} = 200 mA	_	_	1.3	_	_	1.3	V
Vollage		I _{OUT} = 350 mA	-	_	1.6	_	_	1.6	V
Input Voltage	V _{IN(1)}		2.2	_	_	3.3	_	_	V
Imput voltage	V _{IN(0)}		_	_	1.1	_	_	1.7	V
Input Resistance	R _{IN}		50	_	_	50	_	_	kΩ
Serial Data Output Voltage	V _{OUT(1)}	I _{OUT} = -200 μA		3.05	_	4.5	4.75	_	V
Serial Data Output Voltage	V _{OUT(0)}	I _{OUT} = 200 μA	_	0.15	0.3	_	0.15	0.3	V
Maximum Clock Frequency ²	f _c		10	_	-	10	_	_	MHz
	I _{DD(1)}	One output on, OE = L, ST = H	-	_	2.0	_	_	2.0	mA
Logic Supply Current	I _{DD(0)}	All outputs off, OE = H, ST = H, P1 through P8 = L	_	_	100	_	_	100	μA
Output Enable-to-Output Delay	t _{dis(BQ)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Output Enable-to-Output Delay	t _{en(BQ)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Strobe-to-Output Delay	t _{p(STH-QL)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Strobe-to-Output Delay	t _{p(STH-QH)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Output Fall Time	t _f	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	_	_	1.0	μs
Output Rise Time	t _r	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Clock-to-Serial Data Out Delay	t _{p(CH-SQX)}	I _{OUT} = ±200 μA	_	50	_	_	50	_	ns

¹Positive (negative) current is defined as conventional current going into (coming out of) the specified device pin.

Truth Table

Serial		Shift Register Contents	Serial		Latch Contents	Output	Output Contents
Data Input	Clock Input	l ₁ l ₂ l ₃ l ₈	Data Output	Strobe Input	l ₁ l ₂ l ₃ l ₈	Enable Input	l ₁ l ₂ l ₃ l ₈
Н	7	H R ₁ R ₂ R ₇	R ₇				
L	7	L R ₁ R ₂ R ₇	R ₇				
Х		R ₁ R ₂ R ₃ R ₈	R ₈				
		X X X X	Х	L	R ₁ R ₂ R ₃ R ₈		
		P ₁ P ₂ P ₃ P ₈	P ₈	Н	P ₁ P ₂ P ₃ P ₈	L	P ₁ P ₂ P ₃ P ₈
					X X X X	Н	ннн н

L = Low Logic Level

R = Previous State

H = High Logic Level

OE = Output Enable

X = Irrelevant

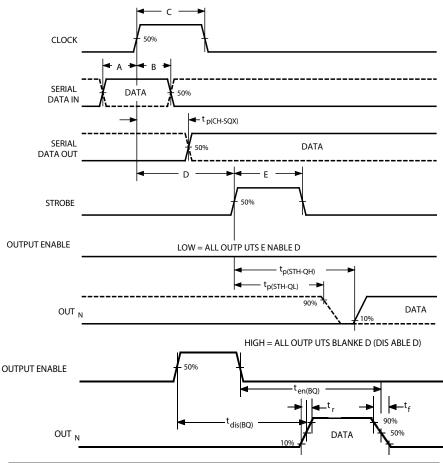
ST = Strobe

²Operation at a clock frequency greater than the specified minimum value is possible but not warranteed.

P = Present State

Timing Requirements and Specifications

(Logic Levels are V_{DD} and Ground)



Key	Description	Symbol	Time (ns)
Α	Data Active Time Before Clock Pulse (Data Set-Up Time)	t _{su(D)}	25
В	Data Active Time After Clock Pulse (Data Hold Time)	t _{h(D)}	25
С	Clock Pulse Width	t _{w(CH)}	50
D	Time Between Clock Activation and Strobe	t _{su(C)}	100
E	Strobe Pulse Width	t _{w(STH)}	50

NOTE: Timing is representative of a 10 MHz clock. Higher speeds may be attainable; operation at high temperatures will reduce the specified maximum clock frequency.

Powering-on with the inputs in the low state ensures that the registers and latches power-on in the low state (POR).

Serial Data present at the input is transferred to the shift register on the logical 0 to logical 1 transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUT-PUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to the respective latch when the STROBE is high (serial-to-parallel conversion). The latches will continue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the OUTPUT ENABLE input be high during serial data entry.

When the OUTPUT ENABLE input is high, all of the output buffers are disabled (OFF). The information stored in the latches or shift register is not affected by the OUTPUT ENABLE input. With the OUTPUT ENABLE input low, the outputs are controlled by the state of their respective latches.



Maximum Allowable Duty Cycle, I_{OLIT} = 200 mA, V_{DD} = 5 V

Number of Ambient Temperature						
Outputs ON	Ambient Temperature					
Outputs ON	25°C	40°C	50°C	60°C	70°C	
A6821SA/A6821EA						
8	90%	79%	72%	65%	57%	
7	100%	90%	82%	74%	65%	
6	100%	100%	96%	86%	76%	
5	100%	100%	100%	100%	91%	
4	100%	100%	100%	100%	100%	
3	100%	100%	100%	100%	100%	
2	100%	100%	100%	100%	100%	
1	100%	100%	100%	100%	100%	
A6821SLW						
8	67%	59%	54%	49%	43%	
7	77%	68%	62%	56%	49%	
6	90%	79%	72%	65%	57%	
5	100%	95%	86%	78%	68%	
4	100%	100%	100%	98%	86%	
3	100%	100%	100%	100%	100%	
2	100%	100%	100%	100%	100%	
1	100%	100%	100%	100%	100%	

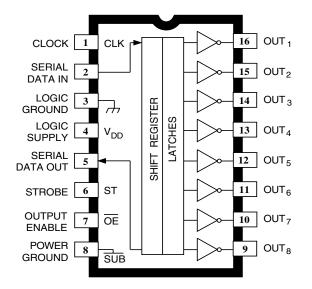
Terminal List Table

Name	Description	Pin
CLK	Clock	1
	Serial Data In	2
	Logic Ground*	3
VDD	Logic Supply	4
	Serial Data Out	5
ST	Strobe	6
ŌĒ	Output Enable (active low)	7
SUB	Power Ground*	8
OUT ₈	Serial Data Output	9
OUT ₇	Serial Data Output	10
OUT ₆	Serial Data Output	11
OUT ₅	Serial Data Output	12
OUT ₄	Serial Data Output	13
OUT ₃	Serial Data Output	14
OUT ₂	Serial Data Output	15
OUT ₁	Serial Data Output	16

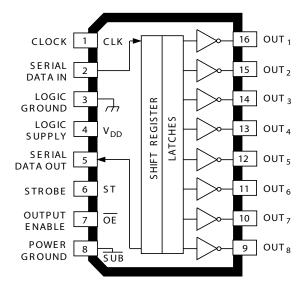
^{*} There is an indeterminate resistance between logic ground and power ground. For proper operation, these terminals must be externally connected together.



Package A 16-pin DIP

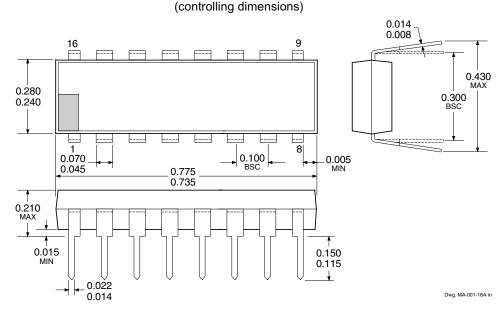


Package LW 16-pin Wide Body SOIC

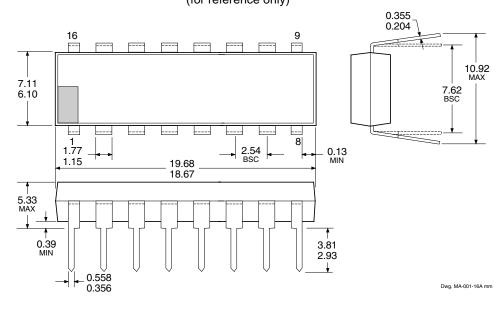


Package A 16-pin DIP

Dimensions in Inches



Dimensions in Millimeters (for reference only)

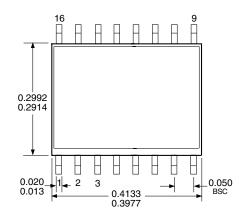


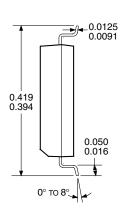
NOTES: 1. Lead thickness is measured at seating plane or below.

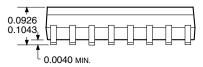
- 2. Lead spacing tolerance is non-cumulative.
- 3. Exact body and lead configuration at vendor's option within limits shown.

Package LW 16-pin Wide Body SOIC

Dimensions in Inches (for reference only)

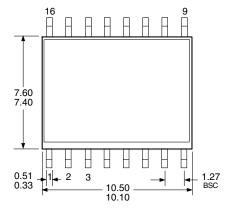


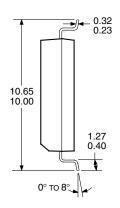


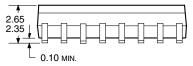


Dwg. MA-008-16A in

Dimensions in Millimeters (controlling dimensions)







Dwg. MA-008-16A mm

NOTES: 1. Lead spacing tolerance is non-cumulative.

2. Exact body and lead configuration at vendor's option within limits shown.

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